

INTRODUCTION

- 1. The contents is subject to change without notice. Please exchange the specification sheets regarding the product's warranty.
- 2. This sheet is not intended to guarantee or provide an approval of implementation of industrial patents.
- 3. We have prepared this sheet as carefully as possible. If you find it incomplete or unsatisfactory in any respect, We would welcome your comments.

This product is compliant with RoHS Directive.

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This product listed here is designed as components or parts for electronics equipment in general consumer use. We do not expect that any of these products would be incorporated or otherwise used as a component or part for the equipment, which requires an extra high reliability, such as satellite, rocket and other space systems, and medical equipment, the functional purpose of which is to keep life.

Product No. / Model The product No. of this crystal oscillator unit is X1G004481004400. The model is SG7050CAN. Suffix : TJGA

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[1] Absolute maximum ratings

Parameter	Symbol	Value	Unit	Note
Supply voltage	Vcc-GND	-0.3 to +4.0	V	
Storage temperature	T_stg	-40 to +125		Stored as bare product after unpacking.
Input voltage	Vin	-0.3 to Vcc+0.3	V	ST Terminal

* Concerning the frequency change, please refer [8] Environmental and mechanical characteristics.

[2] Operating range

		Value				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	Vcc	1.6	-	3.63	V	Symbol : T
Supply voltage	GND	0.0	0.0	0.0	V	
Input voltage	Vin	GND	-	Vcc	V	
Operating temperature	T_use	-40	+25	+85	°C	Symbol : G
Output load condition	L_CMOS	-	-	15	pF	

• Start up time(0 %Vcc \rightarrow 90 %Vcc) of power source should be more than 150 $\mu s.$

• By-pass capacitor (0.01 μF to 0.1 $\mu F)$ is connected near Vcc between Vcc and GND. (Refer to [11] Recommendable patterning)

[3] Frequency characteristics

Output frequency (fo) 11.0592 MHz

Parameter	Symbol	Value $[1 \times 10^{-6}]$	Note
Frequency tolerance	<u>f</u> tol (OSC)	± 50	Symbol : J
Aging	<u>f</u> aging	± 3	T_use=+25 °C, Vcc=3.3 V First year

*1 This includes initial frequency tolerance, temperature characteristics, input voltage characteristics(+/-10% Vcc), and load characteristics, but excludes aging.

[4] Terminal assignment

Top View	
#4	#3
#1	#2

Terminal name	Terminal No.	Terminal type.
ST	1	INPUT
GND	2	—
OUT	3	OUTPUT
Vcc	4	—

 \overline{ST} pin : High or open \rightarrow Specified frequency output = enable

 $\overline{\rm ST}\,$ pin : Low \rightarrow Output is high impedance = disabled

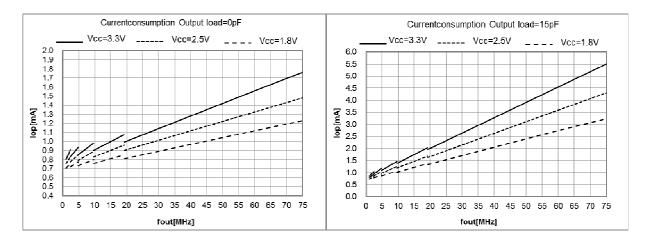
* When the ST terminal is not controlled, it should be connected to the Vcc terminal.

[5] Electrical characteristics

(Please see page 2 [2] Operating range)

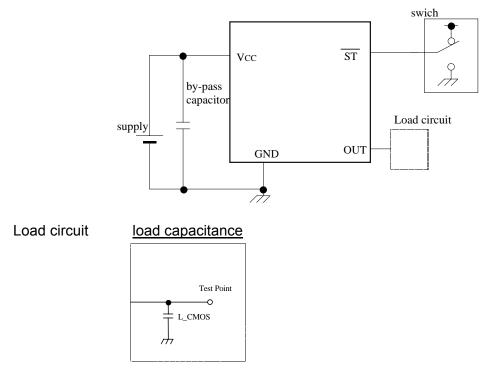
		Value				
Parameter	Symbol	Min.	Max.	Unit	Note	
Start up time	tosc	-	3	ms	t=0 at 90 %Vcc	
		-	1.5		No load, 1 MHz to 20 MHz	
		-	1.8		No load, 20 MHz to 40 MHz Vcc=1.8 V ±10 %	
		-	2.1		No load, 40 MHz to 60 MHz	
			2.4		No load, 60 MHz to 75 MHz	
		-	1.6		No load, 1 MHz to 20 MHz	
Current concumption	Icc	-	2.0	mA	No load, 20 MHz to 40 MHz Vcc=2.5 V ±10 %	
Current consumption	ICC	-	2.4	ШA	No load, 40 MHz to 60 MHz	
			2.8		No load, 60 MHz to 75 MHz	
		-	1.8		No load, 1 MHz to 20 MHz	
		-	2.2		No load, 20 MHz to 40 MHz	
		-	2.6		No load, 40 MHz to 60 MHz	
			3.0		No load, 60 MHz to 75 MHz	
		-	2.1		$\overline{\text{ST}} = \text{GND}$ $\frac{\text{Vcc=1.8 V \pm 10\%}}{\text{Vcc=1.6 V \pm 10\%}}$	
Standby current	I_std	_	2.5	μA	$Vcc=2.5 V \pm 10 \%$	
		-	2.7		Vcc=3.3 V ±10 %	
Output rise time *1	tr	_	3.0	20	20 %Vcc → 80 %Vcc	
Output rise time *1	u	-	3.5	ns	20 %Vcc \rightarrow 80 %Vcc Vcc=1.8 V ±10 %	
Output fall time *1	tf	-	3.0	20	$80 \% Vcc \rightarrow 20 \% Vcc$	
Output fall time *1		-	3.5	ns	80 %Vcc \rightarrow 20 %Vcc Vcc=1.8 V ±10 %	
Symmetry	SYM	45	55	%	50 %Vcc Level	
					Iон = -3 mA , Vcc=1.8 V ±10 %	
High level output voltage	Vон	Vcc-0.4	-	V	Iон = -4 mA , Vcc=2.5 V ±10 %	
					Iон = -6 mA , Vcc=3.3 V ±10 %	
					Іон = 3 mA , Vcc=1.8 V ±10 %	
Low level output voltage	Vol	-	0.4	V	Iон = 4 mA , Vcc=2.5 V ±10 %	
					Iон = 6 mA , Vcc=3.3 V ±10 %	
High level input voltage	Vін	0.8 Vcc	-	V	ST terminal	
Low level input voltage	VIL	-	0.2 Vcc	V	ST terminal	
Input current	Ін	-	10	μA	VIN = VCC	
	lı∟	-10	-	μA	VIN = GND	
Output disable time *2	tstp	-	100	ns	ST terminal High \rightarrow Low	
Output enable time *2	tsta	-	3	ms	\overline{ST} terminal Low \rightarrow High	

Refer to [6] Test circuit [7] Timing chart

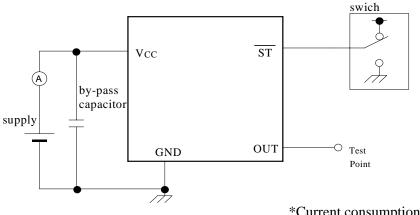


[6] Test circuit

1) Waveform observation



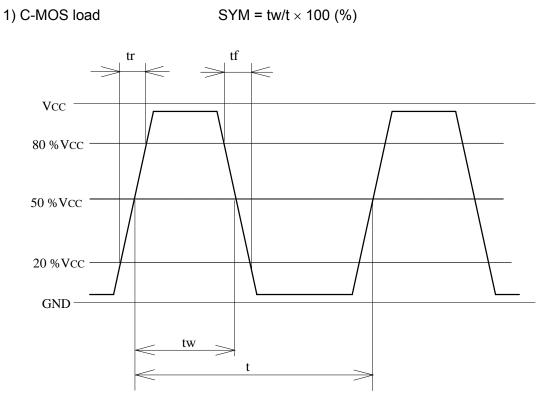
2) Current consumption



*Current consumption under the disable function should be $\overline{ST} = GND$

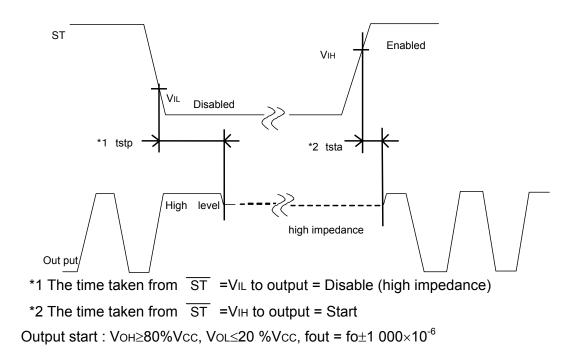
- 3) Condition
 - (1) Oscilloscope
 - Band width should be minimum 5 times higher (wider) than measurement frequency.
 - Probe earth should be placed closely from test point and lead length should be as short as possible.
 - * Recommendable to use miniature socket. (Don't use earth lead.)
 - (2) L_CMOS also includes probe capacitance.
 - (3) By-pass capacitor (0.01 μ F to 0.1 μ F) is placed closely between Vcc and GND.
 - (4) Use the current meter whose internal impedance value is small.
 - (5) Power supply
 - Start up time (0 %Vcc \rightarrow 90 %Vcc) of power source should be more than 150 $\mu s.$
 - Impedance of power supply should be as lowest as possible.

[7] Timing chart



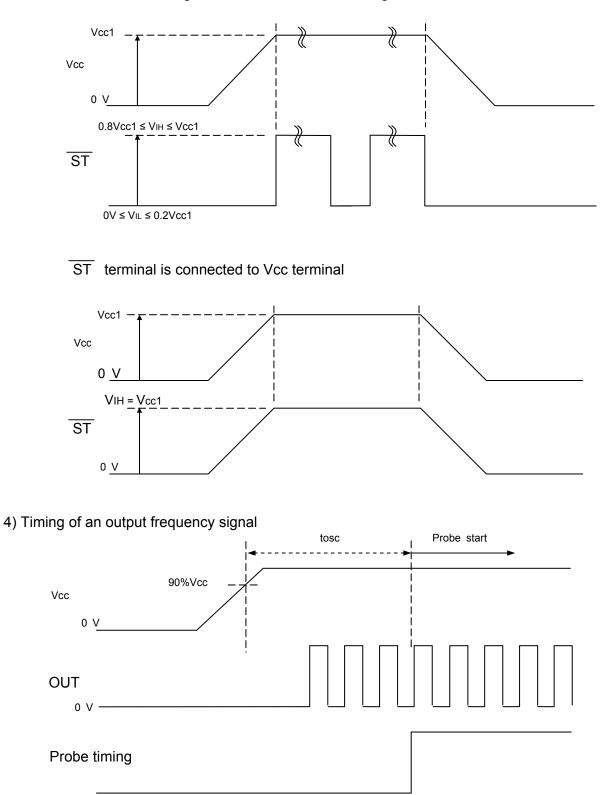
2) ST function and timing

ST function	Osc. circuit	Output status
High or Open	Oscillation	Specified frequency is output : Enable
Low	Oscillation stop	Output becomes high impedance : Disable



3) ST Control timing

ST function is used on the voltage below supply voltage.



ST control timing differs from Vcc control timing



[8] Environmental and mechanical characteristics

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(The company evaluation condition		g examination item and examination condition.)

		Value *1		Test Conditions
No	Item	Δ f / f *2	Electrical	
		[1 × 10 ⁻⁶]	characteristics	
1	High temperature storage	*3 ±20		+125 °C × 1 000 h
2	Low temperature storage	*3 ± 10		-40 °C × 1 000 h
3	High temperature bias	*3 ± 10		+105 °C \times V _{CC} Max. \times 1 000 h
4	Low temperature bias	*3 ± 10		-40 °C \times V _{CC} Max. \times 1 000 h
5	Temperature humidity bias	*3 ±10		+85 °C \times 85 %RH \times V _{CC} Max. \times 1 000 h
6	Tomporatura avala	*3 ± 10		-40 °C ↔ +125 °C
0	Temperature cycle	5 ± 10		30 min. at each temperature 100 cycles
7	Resistance to soldering heat	±3		Convection reflow soldering furnace (3
'	Resistance to soldering heat	± 0		times) Ref. IPC/JEDEC J-STD-020D.1
8	Shock	±3	Satisfy Item [5]	150 g dummy Jig (Standard) drop from 1 500 mm height on the Concrete
			after test.	3 directions 10 times.
				10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s ²
9	Vibration	±2		10 Hz \rightarrow 500 Hz \rightarrow 10 Hz 15 min./cycle
				6 h (2 hours, 3 directions)
10	Seal	1 × 10 ⁻⁹ Pa⋅m³/ s		He leakage detector
11	Solderability	Termination must be 95 % covered with fresh solder		Dip termination into solder bath at +235 °C \pm 5 °C for 5 s (Using Rosin Flux)
12	Pull - off	No peeling-off at a solder part		10 N press for 10 s ± 1 s Ref. EIAJ ED-4702

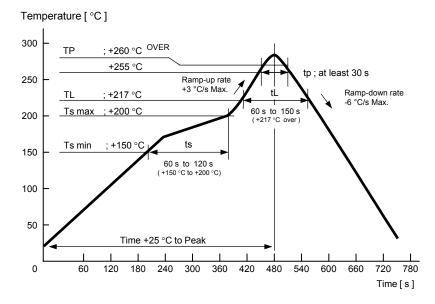
< Notes >

*1 Each test done independently.

*2 Measuring 2 h to 24 h later leaving in room temperature after each test.

*3 Initial value shall be measured after 24 h storage at room temperature after pre-conditioning. Pre-conditioning: Reflow (3 times)

Convection reflow condition (IPC/JEDEC J-STD-020D.1)



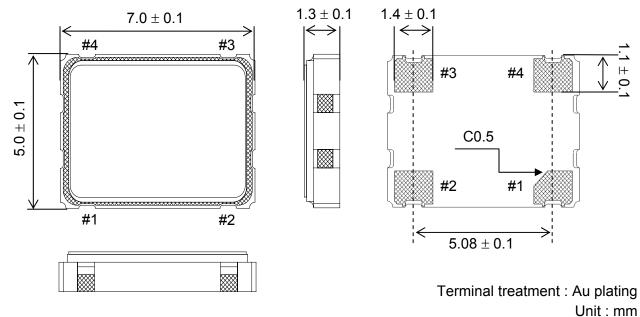
[9] Electro Static Discharge

• ESD

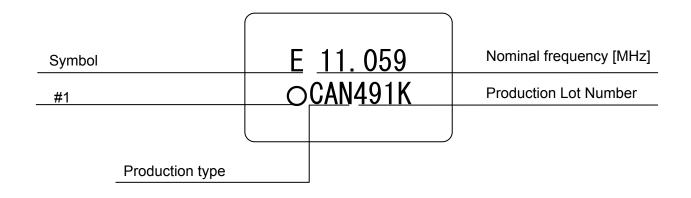
Item	Electrostatic Discharge	Test term
HBM	2 000 V Min.	EIAJ ED-4701-1 C111A,100 pF,1.5 kΩ, 3 times
MM	200 V Min.	EIAJ ED-4701-1 C111,200 pF, 0 Ω, 1 time

[10] Dimensions and marking layout

1) Dimensions



2) Marking layout



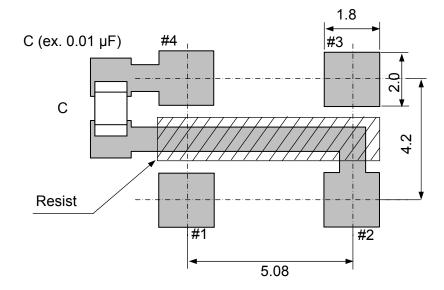
- The above marking layout shows only marking contents and their approximate position and it is not for font, size and exact position.
- Output frequency shall indicate 6 digits (include decimal point), if the value of frequency over 7 digits, the least significant digits will be omitted.

[11] Notes

- 1) This device is made with C-MOS IC. Please take necessary precautions to prevent damage due to electrical static discharge.
- 2) We recommends a 0.01 μ F to 0.1 μ F capacitor must be connected near Vcc between Vcc and GND to obtain stable operation and protect against power line ripple.
- 3) Vcc and GND pattern shall be as large as possible so that high frequency impedance shall be small.
- 4) We cannot recommend to put filtering element into power line so as to reduce noise. Oscillator might be unstable oscillation because high frequency impedance of power line become higher. When use filtering element, please verify electrical construction and or element's spec.
- 5) We doesn't recommend to power on from intermediate electric voltage or extreme fast power on, Those powering conditions may cause no oscillation or abnormal oscillation.
- 6) Power ripple: 200 mV P-P max. Start up time (0 %Vcc→90 %Vcc) of power source should be more than 150 μs.
- 7) A long output line may cause irregular output, so try to make the output line as short as possible.
- 8) Other high-level signal lines may cause incorrect operation, so please do not place high level signal line close to this device.
- This device contains a crystal resonator, so please don't expose excessive shock or vibration. We recommends store device under normal temperature and humidity to keep the specification.
- 10) An automatic insertion is available, however, the internal crystal resonator might be damaged in case that too much shock or vibration is applied by machine condition. Be sure to check your machine condition in advance.
- 11) Ultrasonic cleaning can be used on the SG7050CAN, however, since the oscillator might be damaged under some conditions, please exercise in advance.
- 12) We recommends to use and store under room temperature and normal humidity to secure frequency accuracy and prevent moisture.
- 13) ST -pin has pull-up resistor internally. The resistor value is switched depending on input voltage. Please refer to electrical characteristics.
- 14) Lid is electrically connected to GND. Please don't apply electrical voltage.

[12] Recommendable patterning

The soldering pad sample indicated as like following:



Soldering position (Unit : mm)

To maintain stable operation, provide a 0.01 uF to 0.1 uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

TAPING SPECIFICATION

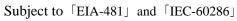
I. Application

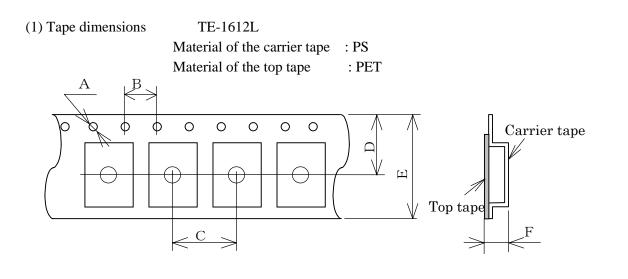
This standard will apply to 7×5 Ceramic package. Spec : CA package

II. Contents

Item No.	Item	Page
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[2]	Inner carton	3
[3]	Shipping carton	
[4]	Marking	4
[5]	Quantity	
[6]	Storage environment	
[7]	Handling	

[1] Taping specification



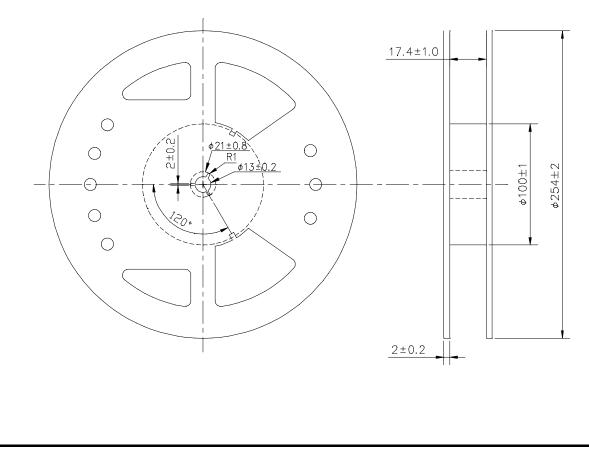


Symbol	А	В	С	D	Е	F
Value	φ 1.5	4.0	8.0	9.25	16.0	2.3

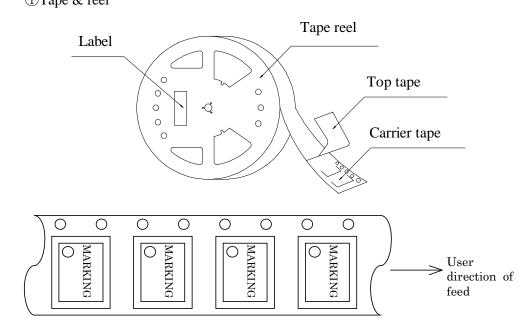
Unit : mm

(2) Reel dimensions

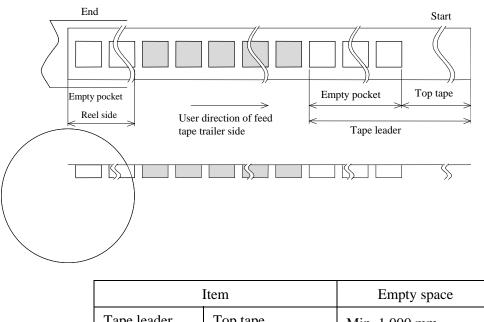
Material of the reel : Conductive polystyrene







0 Start & end point

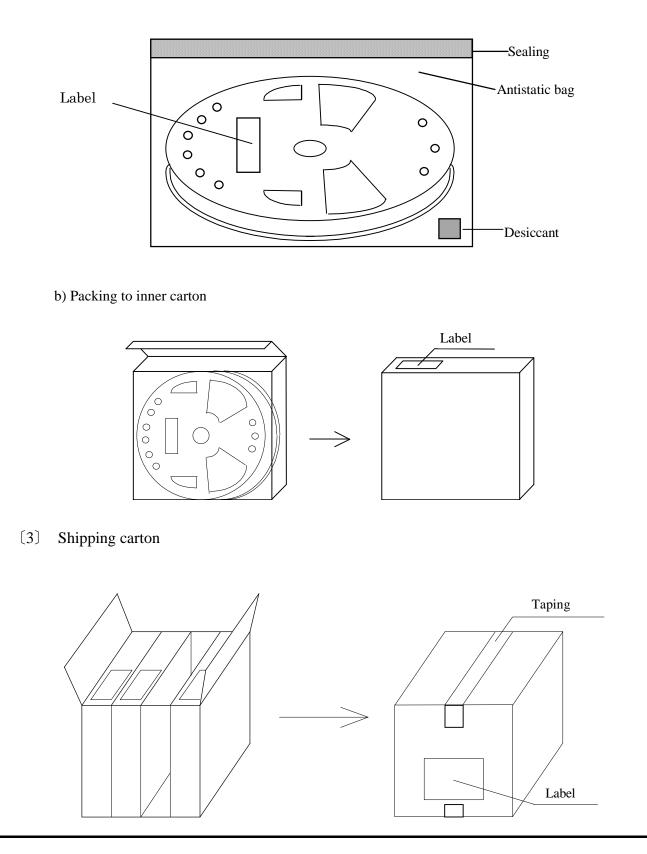


Item		Empty space			
Tape leader	Top tape	Min. 1 000 mm			
	Carrier tape	Min. 160 mm			
Tape trailer	Top tape	Min. 0 mm			
	Carrier tape	Min. 160 mm			

- (4) Peel force of the cover tape
 - ① angle : cover tape during peel off and the direction of unreeling shall be 165° to 180°.
 - 2 peel speed : 300 mm / min.

[2] Inner carton

a) Packing to antistatic bag



[4] Marking

(1) Reel marking

- Reel marking shall consist of :
 - 1) Parts name
 - 2) Quantity
 - 3) Manufacturing date or symbol
 - 4) Manufacturer's date or symbol
 - 5) Others (if necessary)
- (2) Inner carton marking
 - Same as reel marking.
- (3) Shipping carton marking
 - Shipping carton marking shall consist of :
 - 1) Parts name
 - 2) Quantity
- [5] Quantity
 - 1 000 pcs./reel

[6] Storage environment

- (1) Before open the packing, we recommend to keep less than +30 °C and 85 %RH of Humidity, and to use it less than 6 months after delivery.
- (2) We recommend to open Package in immediately before use. After open Package, We recommend to keeps less than 6 month. No need dry air before soldering work if it is less than temperature +30 °C, 85 humidity %RH.
- (3) Not to expose the sun.
- (4) Not to storage with some erosive chemicals.
- (5) Nothing is allowed to put on the reel or carton to prevent mechanical damage.

[7] Handling

• To handle with care to prevent the damage of tape, reel and products.

- PROCESS QUALITY CONTROL Preliminaly -

No. SG7050CxN - 00 - ASE - 1

CRYSTAL OSCILLATOR : SG7050CxN

Manufacturing process chart		Section In Charge	Standards	Inspection, Control Item	Instruments	Inspection Methods	Record
d Crystal IC Base	1	Inspection Section	Purchasing Specification Incoming Inspection Standard	Appearance Dimension	Microscope	Sampling	Data sheet
1 1 1 In-coming Inspection	2	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	100% Inspection	Data sheet
3 Package Set	3	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
(2) Chip Setting (4) Die Attach	4	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Frequency	Microscope	Sampling	Data sheet
Wire Bonding	5	China Plant (Production Section)	Manufacturing Instruction Sheet	Bonding strength Appearance	Pull tester / Gauge Microscope	Sampling	Data sheet
6 Crystal-Mounting	6	China Plant (Production Section)	Manufacturing Instruction Sheet	Mounting strength Appearance	Pull tester Microscope	Sampling 100% Inspection	Data sheet
7 Frequency Adjusting (Crystal)	7	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Frequency	Microscope Counter	Sampling 100% Inspection	Data sheet
8 Hermetic Sealing	8	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
9 High Temp Treatment	9	China Plant (Production Section)	Manufacturing Instruction Sheet			—	
10 Leakage	10	China Plant (Production Section)	Manufacturing Instruction Sheet	Leakage inspection	Measuring equipment	100% Inspection	Data sheet
LDL Inspection	11	China Plant (Production Section)	Manufacturing Instruction Sheet	Characteristic inspection	Measuring equipment	100% Inspection	Data sheet
12 Marking	12	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Visual Inspection	Sampling	Data sheet
13 Electrical Characteristic Inspection		China Plant (Production Section)	Manufacturing Instruction Sheet	Electrical characteristic Master Check	Measuring equipment	100% Inspection	Data sheet
14 Temp Characteristic	14	China Plant (Production Section)	Manufacturing Instruction Sheet	Electrical characteristic Master Check	Measuring equipment	Sampling	Data sheet
15 Appearance Inspection	15	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Master Check	Microscope	100% Inspection	Data sheet
16 Outgoing Inspection	16	China Plant (Production Section)	Delivery Specifications Outgoing Inspection Standard	Electrical characteristic Appearance	Measuring equipment Microscope	Sampling	Data sheet
(17) Taping	17	China Plant (Production Section)	Manufacturing Instruction Sheet	Tape peeling strength Frequency check function	Peeling strength test machine	Sampling	Data sheet
(18) Packing	18	China Plant (Production Section)	Manufacturing Instruction Sheet Daily Shipping List	Customers Type Quantity		_	Delivery Slip

Structure diagram SG7050CAN

